fenew

Technical validation

The consortium proposes the execution of two different **pilots test campaign** to simulate the process for the **separation of plastic** from the **metal** contained in the PCBs: the one run by **Atlantic Copper** and the one of **Tallin University**. **Fraunhofer**, instead, will evaluate the **epoxy chemical recycling** in an **improved pilot plant**.

WEEE collection pilot

ERION will develop and set up **innovative eco-points** to test their effectiveness in enhancing the collection rate of WEEE.

Location

Technical Pilot:

- Seville (Spain) AC
- Tallin (Estonia) TalTech
- Pfinztal (Germany) Fraunhofer

Pilot for the WEEE collection: • Italy - ERION

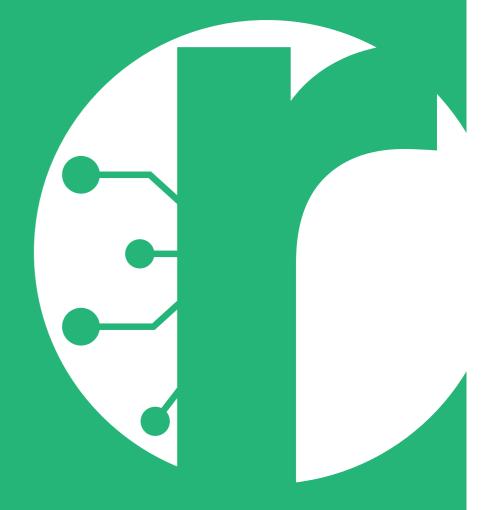




Jenew

Re-cycling of Epoxys from Nonferrous E-Waste





Background

Printed Circuit Boards (PCBs) contain significant amounts of recoverable **secondary** raw materials such as copper, gold, silver, palladium and platinum. Their recycling is nowadays strategic for their scarcity or inhomogeneous distribution on Earth, and the economic roles they play for countries.

The production of **plastic** accounts for 3.8% of global CO, emissions and it is estimated that in 2050 it will be responsible for 13% of them. Plastic is one of the most difficult wastes to recycle. Moreover, to manufacture a kilogram of plastic, about 3.5 kg of CO, are generated, but to manufacture a kilogram of recycled plastic, 1.7 kg of CO, are generated. Therefore, recycling is the best option to give waste a second life.

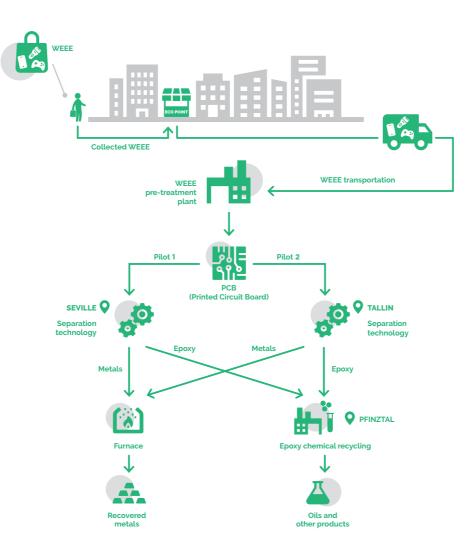
In addition, in 2019, in Europe, as average, **only** 48% of Waste from Electric and Electronical Equipment (WEEE) has been collected. This small and inconstant volume hinders the possibility to create a strong WEEE recycling chain that instead could bring economic and environmental benefits to the society as closed loop in the circular economy framework.

The RENEW Project

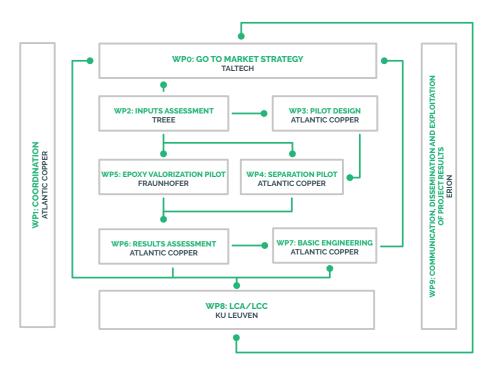
RENEW project is a three-year project funded Purpose of RENEW project is to reduce the by the EIT RawMaterials.

The project aims at validating **technologies** that allow the **separation** of plastic from of plastics and studying their recovery. metals contained in the PCBs that are found in WEEE, as well as the study and validation of a technology for the **recovery** of the **separated** plastic.

carbon footprint of WEEE recycling process in the **copper sector**, minimizing the presence Acting at the beginning of the chain, a part of the project will be dedicated to the test of an innovative eco-point to increase the amount of collected WEEE.



Project Implementation



Project objectives

- · Increase the metal treatment capacity of smelting furnaces
- Study ways to recover and valorise the epoxy
- Improve the recycling of PCBs
- **Reduce** the PCBs recycling process CO footprint
- Test innovative collection eco-point

